

Docket No.: 80422(302761)

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Kunihiro Kakihara et al.

Application No.: 10/562,007

Confirmation No.: 1070

Filed: December 23, 2005

Art Unit: 1791

For: HEAT-TREATED RESIN MOLDINGS AND

Examiner: M. V. Ewald

HEAT-TREATING APPARATUS FOR SOME

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated September 8, 2008, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 3 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 4 of this paper.

An **Appendix** including amended drawing figures is attached following page 4 of this paper.